

<IGBT Modules>

# CM600DY-24T

HIGH POWER SWITCHING USE INSULATED TYPE



**Dimension in mm** 

RoHS Directive compliantUL Recognized under UL1557, File No.E323585

### dual switch (half-bridge)

### APPLICATION

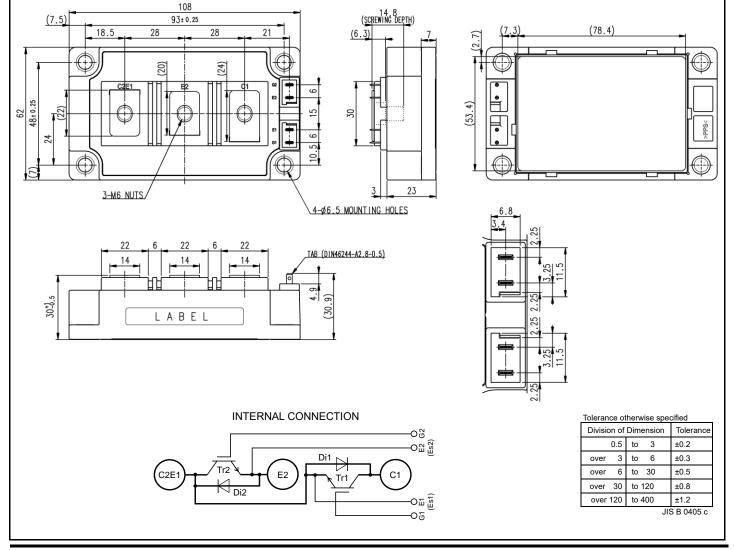
AC Motor Control, Motion/Servo Control, Power supply, etc.

### **OPTION** (Below options are available.)

•PC-TIM (Phase Change Thermal Interface Material) pre-apply (Note8)

•VcEsat selection for parallel connection

### **OUTLINE DRAWING & INTERNAL CONNECTION**



### MAXIMUM RATINGS (Tvj=25 °C, unless otherwise specified)

| Symbol            | Item                           | Conditions                                      | Rating      | Unit |  |
|-------------------|--------------------------------|---|-------------|------|--|
| V <sub>CES</sub>  | Collector-emitter voltage      | G-E short-circuited                             | 1200        | V    |  |
| $V_{\text{GES}}$  | Gate-emitter voltage           | C-E short-circuited                             | ± 20        | V    |  |
| lc                |                                | DC, T <sub>C</sub> =144 °C* (Note2, 4)          | 600         | •    |  |
| I <sub>CRM</sub>  | Collector current              | Pulse, Repetitive (Note3)                       | 1200        | A    |  |
| P <sub>tot</sub>  | Total power dissipation        | T <sub>c</sub> =25 °C (Note2, 4)                | 6250        | W    |  |
| IE (Note1)        |                                | DC (Note2)                                      | 600         | •    |  |
| IERM (Note1)      | Emitter current                | Pulse, Repetitive (Note3)                       | 1200        | A    |  |
| Visol             | Isolation voltage              | Terminals to base plate, RMS, f=60 Hz, AC 1 min | 4000        | V    |  |
| T <sub>jmax</sub> | Maximum junction temperature   | Instantaneous event (overload) (Note8)          | 175         | °C   |  |
| T <sub>Cmax</sub> | Maximum case temperature       | (Note4,8)                                       | 150*        | C    |  |
| Tjop              | Operating junction temperature | Continuous operation (under switching) (Note8)  | -40 ~ +150  | °C   |  |
| T <sub>stg</sub>  | Storage temperature            | -   | -40 ~ +150* | 1    |  |

### ELECTRICAL CHARACTERISTICS (Tvj=25 °C, unless otherwise specified)

| Symbol                             | Itom   | Conditions  |                         | Limits |      |      | Linit |
|------------------------------------|--|---|-------------------------|--------|------|------|-------|
| Symbol                             | Item   | Conditions  |                         | Min.   | Тур. | Max. | Unit  |
| I <sub>CES</sub>                   | Collector-emitter cut-off current                  | V <sub>CE</sub> =V <sub>CES</sub> , G-E short-circuited   |                         | -      | -    | 1.0  | mA    |
| I <sub>GES</sub>                   | Gate-emitter leakage current                       | V <sub>GE</sub> =V <sub>GES</sub> , C-E short-circuited   |                         | -      | -    | 0.5  | μA    |
| $V_{\text{GE(th)}}$                | Gate-emitter threshold voltage                     | I <sub>C</sub> =60 mA, V <sub>CE</sub> =10 V  |                         | 5.4    | 6.0  | 6.6  | V     |
|                                    |  | I <sub>C</sub> =600 A, V <sub>GE</sub> =15 V,   | T <sub>vj</sub> =25 °C  | -      | 1.75 | 2.05 | V     |
| V <sub>CEsat</sub>                 |  | Refer to the figure of test circuit   | T <sub>vj</sub> =125 °C | -      | 2.00 | -    |       |
| (Terminal)                         |  | (Note5)   | T <sub>vj</sub> =150 °C | -      | 2.10 | -    |       |
|                                    | Collector-emitter saturation voltage               | I <sub>C</sub> =600 A,  | T <sub>vj</sub> =25 °C  | -      | 1.55 | 1.80 | V     |
| V <sub>CEsat</sub>                 |  | V <sub>GE</sub> =15 V,  | T <sub>vj</sub> =125 °C | -      | 1.75 | -    |       |
| (Chip)                             |  | (Note5)   | T <sub>vj</sub> =150 °C | -      | 1.80 | -    |       |
| Cies                               | Input capacitance                                  | V <sub>CE</sub> =10 V, G-E short-circuited  |                         | -      | -    | 123  | nF    |
| C <sub>oes</sub>                   | Output capacitance                                 |   |                         | -      | -    | 3.6  |       |
| Cres                               | Reverse transfer capacitance                       |   |                         | -      | -    | 1.5  |       |
| Q <sub>G</sub>                     | Gate charge  | V <sub>CC</sub> =600 V, I <sub>C</sub> =600 A, V <sub>GE</sub> =15 V  |                         | -      | 3.7  | -    | μC    |
| t <sub>d(on)</sub>                 | Turn-on delay time                                 | V <sub>cc</sub> =600 V, I <sub>c</sub> =600 A, V <sub>GE</sub> =±15 V,<br>R <sub>G</sub> =1.0 Ω, Inductive load |                         | -      | -    | 500  | ns    |
| t <sub>r</sub>                     | Rise time  |   |                         | -      | -    | 200  |       |
| $t_{d(off)}$                       | Turn-off delay time                                |   |                         | -      | -    | 600  |       |
| t <sub>f</sub>                     | Fall time  |   |                         | -      | -    | 300  |       |
| (Nists 4)                          |  | I <sub>E</sub> =600 A, G-E short-circuited,   | T <sub>vj</sub> =25 °C  | -      | 1.85 | 2.25 |       |
| V <sub>EC</sub> (Note.1)           | Terminal) Emitter-collector voltage (Note.1) Chip) | Refer to the figure of test circuit   | T <sub>vj</sub> =125 °C | -      | 2.00 | -    | V     |
| (Terminal)                         |  | (Note5)   | T <sub>vj</sub> =150 °C | -      | 2.00 | -    |       |
|                                    |  | I <sub>E</sub> =600 A,  | T <sub>vj</sub> =25 °C  | -      | 1.65 | 2.00 |       |
|                                    |  | G-E short-circuited,<br>(Note5)   | T <sub>vj</sub> =125 °C | -      | 1.65 | -    | V     |
| (Cnip)                             |  |   | T <sub>vj</sub> =150 °C | -      | 1.65 | -    |       |
| t <sub>rr</sub> <sup>(Note1)</sup> | Reverse recovery time                              | V <sub>CC</sub> =600 V, I <sub>E</sub> =600 A, V <sub>GE</sub> =±15 V,  |                         | -      | -    | 400  | ns    |
| Q <sub>rr</sub> (Note1)            | Reverse recovery charge                            | $R_{G}$ =1.0 $\Omega$ , Inductive load  |                         | -      | 60   | -    | μC    |
| Eon                                | Turn-on switching energy per pulse                 | V <sub>CC</sub> =600 V, I <sub>C</sub> =I <sub>E</sub> =600 A,  |                         | -      | 56.6 | -    |       |
| E <sub>off</sub>                   | Turn-off switching energy per pulse                | V <sub>GE</sub> =±15 V, R <sub>G</sub> =1.0 Ω, T <sub>vj</sub> =150 °C,   |                         | -      | 64.3 | -    | mJ    |
| Err (Note1)                        | Reverse recovery energy per pulse                  | Inductive load  |                         | -      | 38.2 | -    | mJ    |
| R <sub>CC'+EE'</sub>               | Internal lead resistance                           | Main terminals-chip, per switch, Tc=25  | °C (Note4)              | -      | 0.3  | -    | mΩ    |
| r <sub>q</sub>                     | Internal gate resistance                           | Per switch  |                         | -      | 0.67 | -    | Ω     |

\*: The value of PC-TIM applied module is limited by the heat resistant temperature of PC-TIM.

### THERMAL RESISTANCE CHARACTERISTICS

| Symbol         | Item                       | Conditions   | Limits |      |      | Unit   |
|----------------|----------------------------|--|--------|------|------|--------|
|                |                            | Conditions   | Min.   | Тур. | Max. | Unit   |
| $R_{th(j-c)Q}$ | Thermal resistance         | Junction to case, per Inverter IGBT (Note4)                        | -      | -    | 24   | K/kW   |
| $R_{th(j-c)D}$ |                            | Junction to case, per Inverter FWD (Note4)                         | -      | -    | 42   | r\/KVV |
| $R_{th(c-s)}$  | Contact thermal resistance | Case to heat sink, per 1 module Thermal grease applied (Note4,6,8) | -      | 13.3 | -    | K/kW   |

### **MECHANICAL CHARACTERISTICS**

| Symbol           | ltom                   | Conditions                     |           | Limits |      |      | Linit |
|------------------|------------------------|--------------------------------|-----------|--------|------|------|-------|
|                  | Item                   |                                |           | Min.   | Тур. | Max. | Unit  |
| Mt               | Mounting torque        | Main terminals                 | M 6 screw | 3.5    | 4.0  | 4.5  | N∙m   |
| Ms               | Mounting torque        | Mounting to heat sink          | M 6 screw | 3.5    | 4.0  | 4.5  | N∙m   |
| ds               | Creepage distance      | Terminal to terminal           |           | 17.3   | -    | -    | mm    |
|                  |                        | Terminal to base plate         |           | 25.3   | -    | -    |       |
| d <sub>a</sub> ( | Clearance              | Terminal to terminal           |           | 12.6   | -    | -    |       |
|                  | Clearance              | Terminal to base plate         |           | 21.8   | -    | -    | mm    |
| ec               | Flatness of base plate | On the centerline X, Y (Note7) |           | ±0     | -    | +200 | μm    |
| m                | mass                   | -                              |           | -      | 260  | -    | g     |

\*. This product is compliant with the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) directive 2011/65/EU and (EU) 2015/863.EU.

Note1. Represent ratings and characteristics of the anti-parallel, emitter-collector free-wheeling diode (FWD).

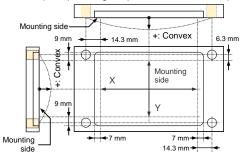
2. Junction temperature (T  $_{\nu j}$  ) should not increase beyond T  $_{\nu j\,m\,a\,x}$  rating.

3. Pulse width and repetition rate should be such that the device junction temperature  $(T_{vj})$  dose not exceed  $T_{vjmax}$  rating.

4. Case temperature (T<sub>c</sub>) and heat sink temperature (T<sub>s</sub>) are defined on the each surface (mounting side) of base plate and heat sink just under the chips. Refer to the figure of chip location.

5. Pulse width and repetition rate should be such as to cause negligible temperature rise. Refer to the figure of test circuit.

- 6. Typical value is measured by using thermally conductive grease of  $\lambda$ =3.0 W/(m·K)/D<sub>(C-S)</sub>=50 µm.
- 7. The base plate (mounting side) flatness measurement points (X, Y) are shown in the following figure.



8. Long term performance related to thermal conductive grease and PC-TIM (including but not limited to aspects such as the increase of thermal resistance due to pumping out, etc.) should be verified under your specific application conditions. Each temperature condition (T<sub>vj max</sub>, T<sub>vj op</sub>, T<sub>C max</sub>) must be maintained below the maximum rated temperature throughout consideration of the temperature rise even for long term usage.

### <IGBT Modules> CM600DY-24T HIGH POWER SWITCHING USE INSULATED TYPE

### **RECMENDED OPERATING CONDITIONS**

| Symbol            | Itom                          | Conditions                             | Limits |      |      | Unit |
|-------------------|-------------------------------|--|--------|------|------|------|
|                   | Item                          |  | Min.   | Тур. | Max. | Unit |
| V <sub>cc</sub>   | (DC) Supply voltage           | Applied across C1-E2 terminals         | -      | 600  | 850  | V    |
| $V_{\text{GEon}}$ | Gate (-emitter drive) voltage | Applied across G1-Es1/G2-Es2 terminals | 13.5   | 15.0 | 16.5 | V    |
| R <sub>G</sub>    | External gate resistance      | Per switch                             | 1.0    | -    | 10   | Ω    |

### CHIP LOCATION (Top view)

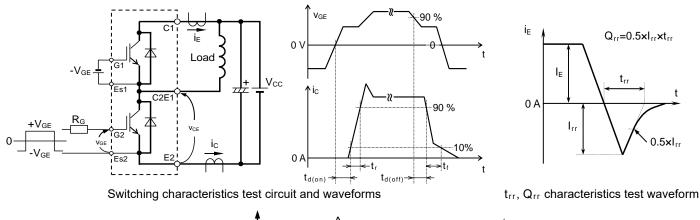
(108)(93) 50.4 72.4 δ ∞ 61.4 0 32. 21 Œ ÷ 44.8 44.8 DiazenTr2 Tr22 Di2 Tr2 C1 44.2 (62) (48) E1 T<u>i</u>l1⊢Dii1 Tr1 18.7 17.9-Tr1—D∔1⊣ G + + 0 ф 0 ¢ Œ 66.4 37.9-8 77.4-0 27 48. LABEL SIDE

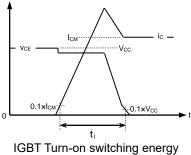
Tr1/Tr2: IGBT, Di1/Di2: FWD

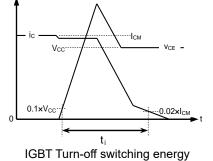
Dimension in mm, tolerance: ±1 mm

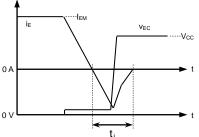
### <IGBT Modules> CM600DY-24T HIGH POWER SWITCHING USE INSULATED TYPE

### **TEST CIRCUIT AND WAVEFORMS**







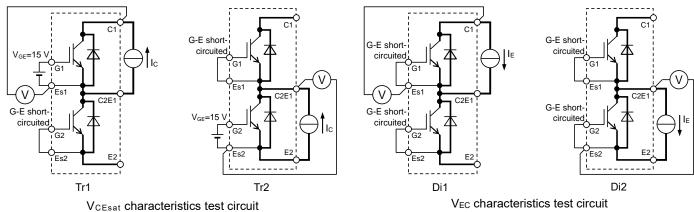


t

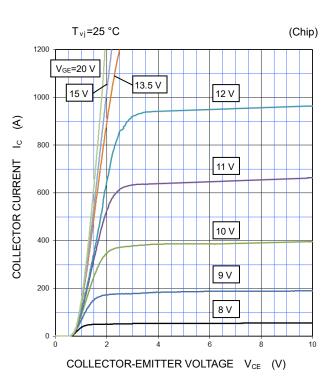
FWD Reverse recovery energy

Turn-on / Turn-off switching energy and Reverse recovery energy test waveforms (Integral time instruction drawing)

### **TEST CIRCUIT**

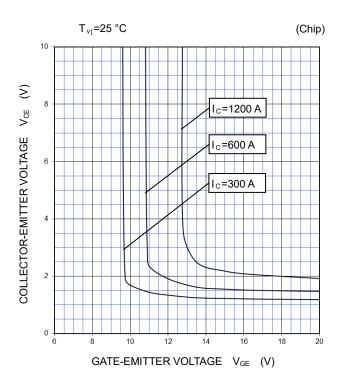


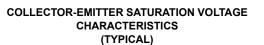
### PERFORMANCE CURVES

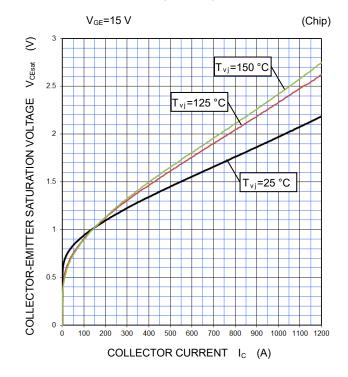


OUTPUT CHARACTERISTICS (TYPICAL)

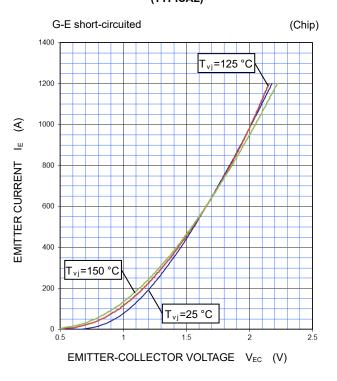
# COLLECTOR-EMITTER VOLTAGE CHARACTERISTICS (TYPICAL)



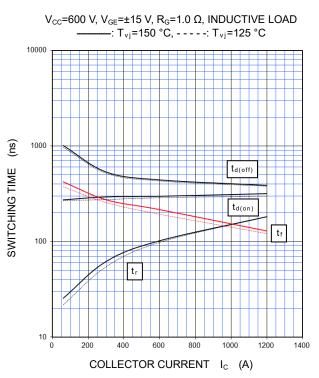




### FREE WHEELING DIODE FORWARD CHARACTERISTICS (TYPICAL)

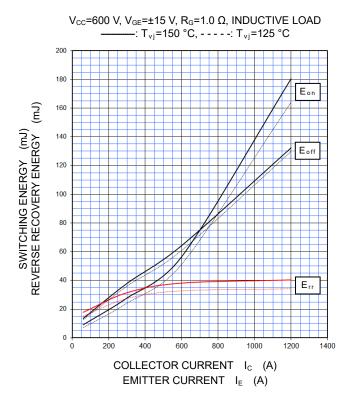


### PERFORMANCE CURVES



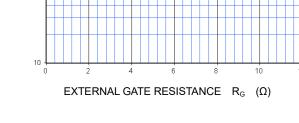
# HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL)

# HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL)

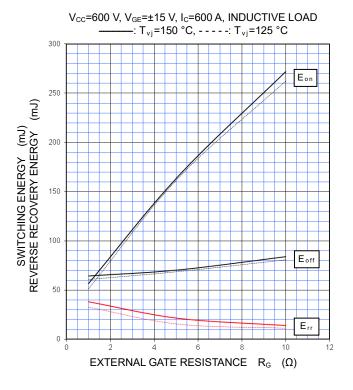


# (TYPICAL) $V_{CC}=600 \text{ V}, V_{GE}=\pm 15 \text{ V}, I_C=600 \text{ A}, \text{INDUCTIVE LOAD}$ $\therefore T_{vj}=150 \text{ °C}, ----: T_{vj}=125 \text{ °C}$ 1000 (100)

HALF-BRIDGE SWITCHING CHARACTERISTICS

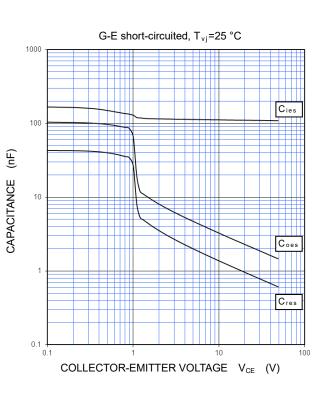


# HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL)



### <IGBT Modules> CM600DY-24T HIGH POWER SWITCHING USE **INSULATED TYPE**

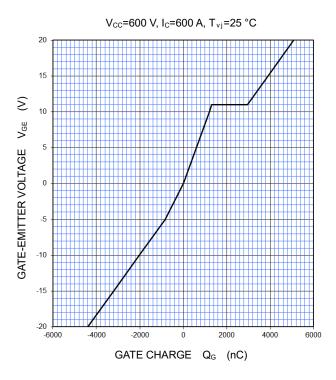
### **PERFORMANCE CURVES**

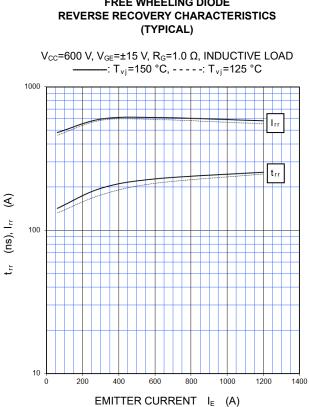


**CAPACITANCE CHARACTERISTICS** 

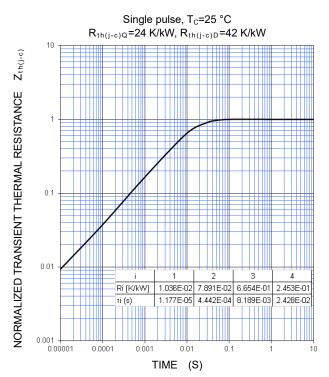
(TYPICAL)

### GATE CHARGE CHARACTERISTICS (TYPICAL)





### TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (MAXIMUM)

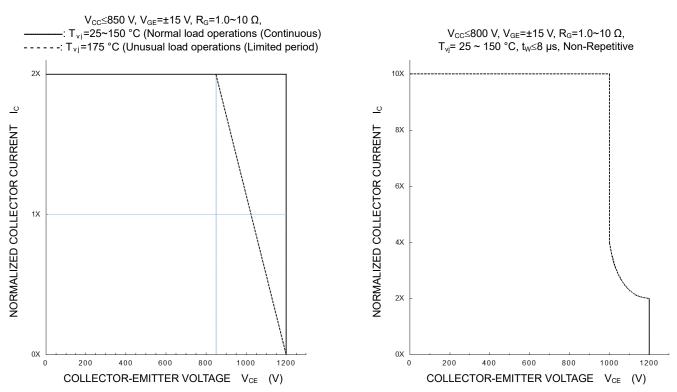


# FREE WHEELING DIODE

Publication Date : December 2020

### PERFORMANCE CURVES

### TURN-OFF SWITCHING SAFE OPERATING AREA (REVERSE BIAS SAFE OPERATING AREA) (MAXIMUM)



Note: The characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

SHORT-CIRCUIT SAFE OPERATING AREA

(MAXIMUM)

### Important Notice

The information contained in this datasheet shall in no event be regarded as a guarantee of conditions or characteristics. This product has to be used within its specified maximum ratings, and is subject to customer's compliance with any applicable legal requirement, norms and standards.

Except as otherwise explicitly approved by Mitsubishi Electric Corporation in a written document signed by authorized representatives of Mitsubishi Electric Corporation, our products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.

In usage of power semiconductor, there is always the possibility that trouble may occur with them by the reliability lifetime such as Power Cycle, Thermal Cycle or others, or when used under special circumstances (e.g. condensation, high humidity, dusty, salty, highlands, environment with lots of organic matter / corrosive gas / explosive gas, or situations which terminals of semiconductor products receive strong mechanical stress). Therefore, please pay sufficient attention to such circumstances. Further, depending on the technical requirements, our semiconductor products may contain environmental regulation substances, etc. If there is necessity of detailed confirmation, please contact our nearest sales branch or distributor.

The contents or data contained in this datasheet are exclusively intended for technically trained staff. Customer's technical departments should take responsibility to evaluate the suitability of Mitsubishi Electric Corporation product for the intended application and the completeness of the product data with respect to such application. In the customer's research and development, please evaluate it not only with a single semiconductor product but also in the entire system, and judge whether it's applicable. As required, pay close attention to the safety design by installing appropriate fuse or circuit breaker between a power supply and semiconductor products to prevent secondary damage. Please also pay attention to the application note and the related technical information.

# Keep safety first in your circuit designs!

Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of non-flammable material or (iii) prevention against any malfunction or mishap.

## Notes regarding these materials

- •These materials are intended as a reference to assist our customers in the selection of the Mitsubishi Electric Semiconductor product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Mitsubishi Electric Corporation or a third party. Mitsubishi Electric Corporation assumes no responsibility for any damage, or infringement of any thirdparty's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials. •All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Mitsubishi Electric Corporation without notice due to product improvements or other reasons. It is therefore recommended that customers contact Mitsubishi Electric Corporation or an authorized Mitsubishi Electric Semiconductor product distributor for the latest product information before purchasing a product listed herein. The information described here may contain technical inaccuracies or typographical errors. Mitsubishi Electric Corporation assumes no responsibility for any damage. liability, or other loss rising from these inaccuracies or errors. Please also pay attention to information published by Mitsubishi Electric Corporation by various means, including the Mitsubishi Electric Semiconductor home page (https://www.MitsubishiElectric.com/semiconductors/). •When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Mitsubishi Electric Corporation assumes no responsibility for any damage, liability or other loss resulting from the information contained herein •Mitsubishi Electric Corporation semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Electric Semiconductor product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use. •The prior written approval of Mitsubishi Electric Corporation is necessary to reprint or reproduce in whole or in part these materials. •If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination. Any diversion or re-export contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.
- •Please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Electric Semiconductor product distributor for further details on these materials or the products contained therein.

Generally the listed company name and the brand name are the trademarks or registered trademarks of the respective companies.

© Mitsubishi Electric Corporation

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Mitsubishi Electric: CM600DY-24T